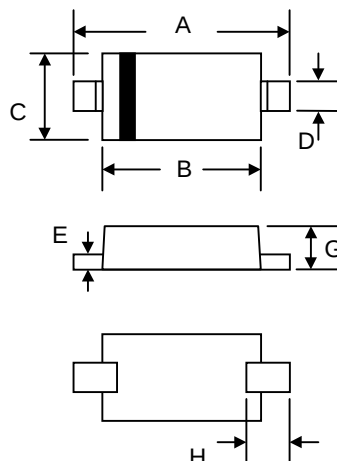
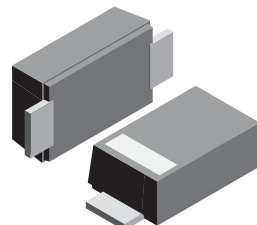


Features

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance

Mechanical Data

- Case: SOD-323, Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: 0.004 grams (approx.)
- Marking: K 4 5



SOD-323		
Dim	Min	Max
A	2.30	2.70
B	1.75	1.95
C	1.15	1.35
D	0.25	0.35
E	0.05	0.15
G	0.70	0.95
H	0.30	—
All Dimensions in mm		

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	V
RMS Reverse Voltage	$V_{R(RMS)}$	40	V
Forward Continuous Current	I_{FM}	100	mA
Forward Surge Current @ $t < 8.3\text{ms}$	I_{FSM}	1.0	A
Power Dissipation	P_d	200	mW
Thermal Resistance Junction to Ambient Air (Note 1)	R_{JA}	500	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-40 to +125	$^\circ\text{C}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage	$V_{(BR)R}$	45				$I_R = 100\text{ A}$
Forward Voltage	V_F		370	450	mV	$I_F = 10\text{mA}$
Reverse Leakage Current	I_R		0.07	1.0	A	$V_R = 10\text{V}$
Total Capacitance	C_T		6.0		pF	$V_R = 10\text{V}, f = 1.0\text{MHz}$

- Note:
1. Device mounted on FR-5 PCB 1.0 x 0.75 x 0.062 inch pad layout as shown on Diodes, Inc. sugges
 2. Short duration pulse test to minimize self-heating effect.

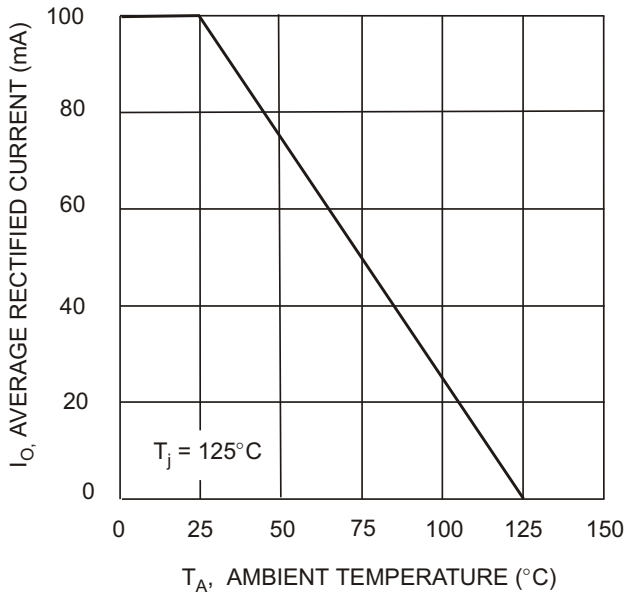


Fig. 1 Forward Current Derating Curve

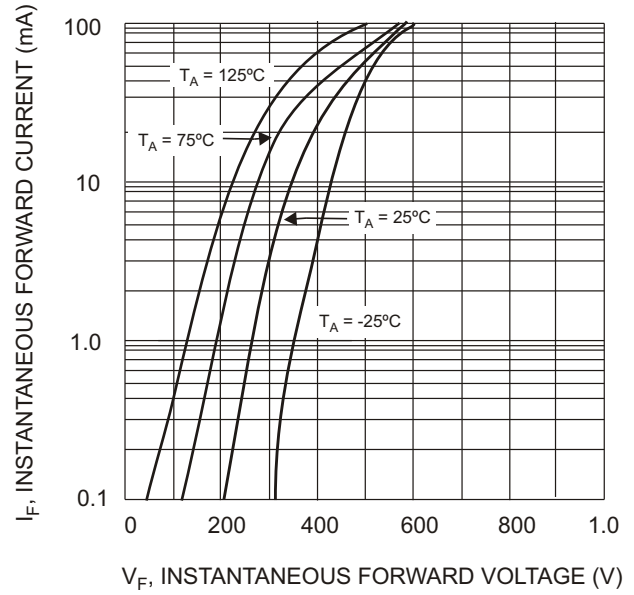


Fig. 2 Typical Forward Characteristics

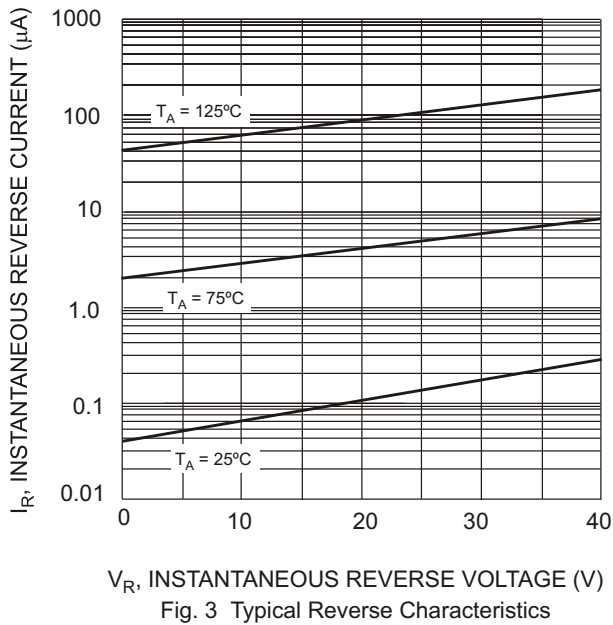


Fig. 3 Typical Reverse Characteristics

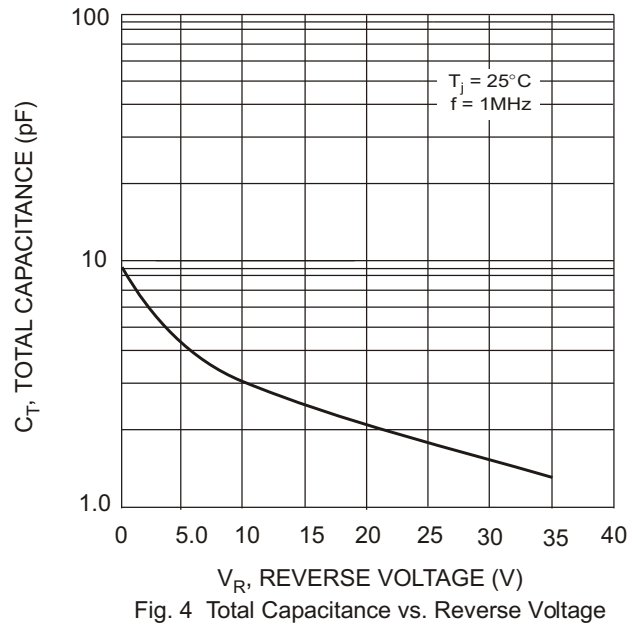


Fig. 4 Total Capacitance vs. Reverse Voltage